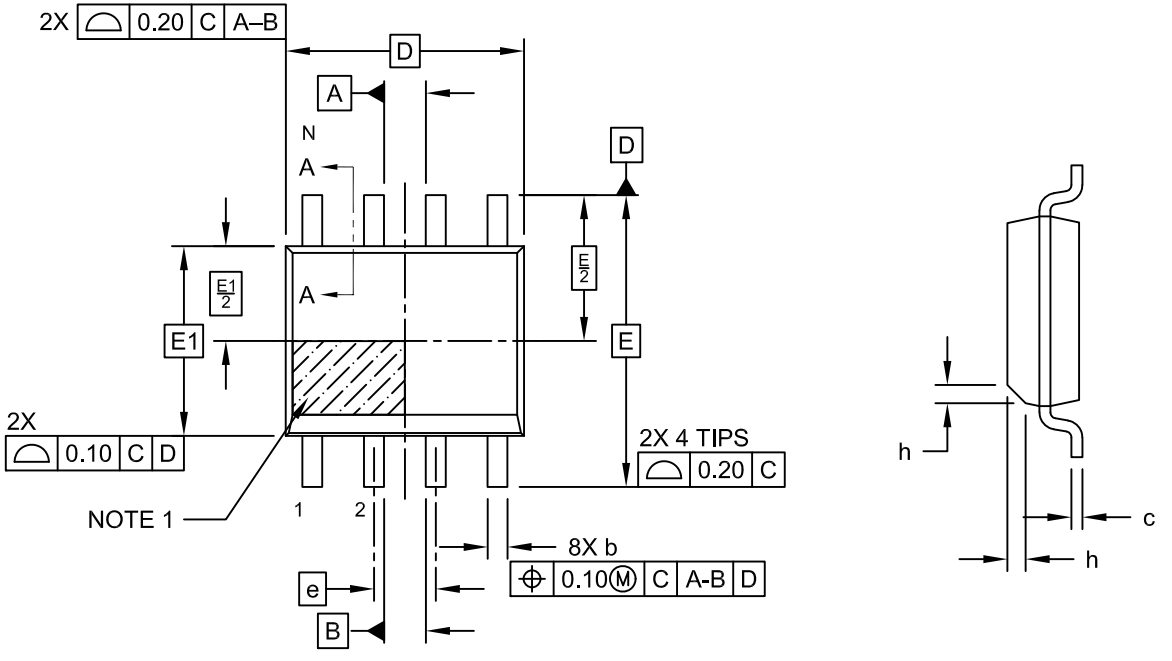
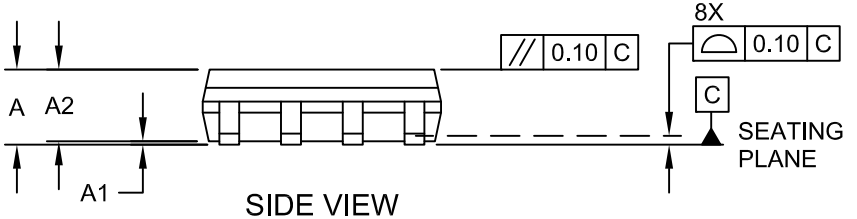
8-Lead Thermally Enhanced Plastic Small Outline (S7X) - Narrow, 3.90 mm Body [SOIC] With 2.2 x 3.0 mm Exposed Pad

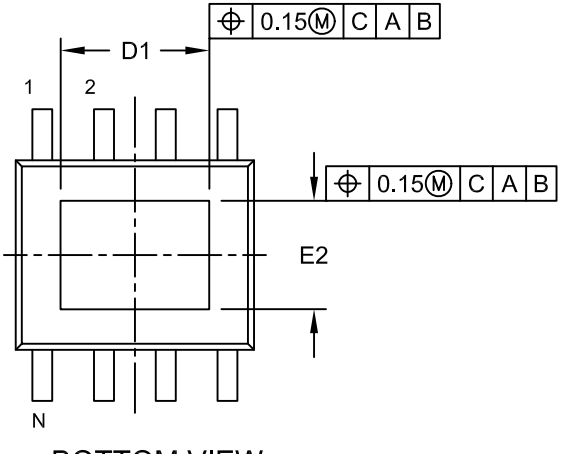
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW



BOTTOM VIEW